

14.22mm (0.56INCH) FOUR DIGIT NUMERIC DISPLAY

Part Number: CA56-21SYKWA

Super Bright Yellow

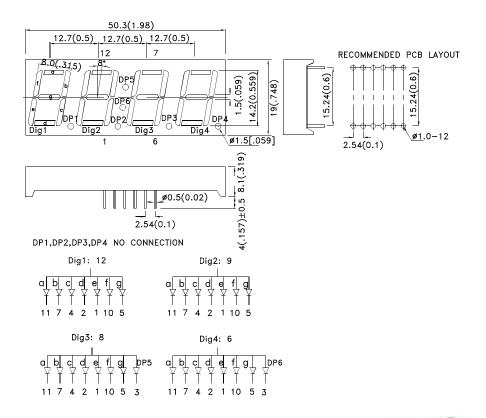
Features

- 0.56 inch digit height.
- Low current operation.
- Excellent character appearance.
- Easy mounting on P.C. boards or sockets.
- Mechanically rugged.
- Standard: gray face, white segment.
- RoHS compliant.

Description

The Super Bright Yellow device is made with AlGaInP (on GaAs substrate) light emitting diode chip.

Package Dimensions& Internal Circuit Diagram



Notes

1. All dimensions are in millimeters (inches), Tolerance is ±0.25(0.01")unless otherwise noted.

2. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAF0647 REV NO: V.4 DATE: DEC/29/2010

APPROVED: WYNEC CHECKED: Joe Lee DRAWN: C.H.Han



PAGE: 1 OF 6

ERP: 1304000324

Selection Guide

| Part No. | Dice | Lens Type | lv (ucd) [1] @ 10mA | | Description |
|--------------|-------------------------------|----------------|------------------------|-------|--------------|
| | | | Min. | Тур. | - |
| CA56-21SYKWA | Super Bright Yellow (AlGaInP) | White Diffused | 31000 | 95000 | Common Anode |

Electrical / Optical Characteristics at TA=25℃

| Symbol | Parameter | Device | Тур. | Max. | Units | Test Conditions |
|--------|--------------------------|---------------------|------|------|-------|--------------------|
| λpeak | Peak Wavelength | Super Bright Yellow | 590 | | nm | IF=20mA |
| λD [1] | Dominant Wavelength | Super Bright Yellow | 590 | | nm | IF=20mA |
| Δλ1/2 | Spectral Line Half-width | Super Bright Yellow | 20 | | nm | IF=20mA |
| С | Capacitance | Super Bright Yellow | 20 | | pF | VF=0V;f=1MHz |
| VF [2] | Forward Voltage | Super Bright Yellow | 2.0 | 2.5 | V | IF=20mA |
| lr | Reverse Current | Super Bright Yellow | | 10 | uA | V _R =5V |

Notes:

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

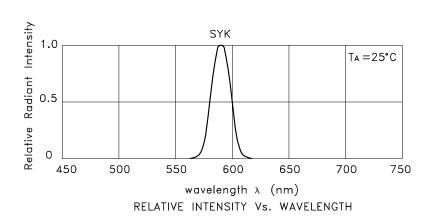
Absolute Maximum Ratings at TA=25℃

| Parameter | Super Bright Yellow | Units |
|--|-----------------------|-------|
| Power dissipation | 75 | mW |
| DC Forward Current | 30 | mA |
| Peak Forward Current [1] | 175 | mA |
| Reverse Voltage | 5 | V |
| Operating / Storage Temperature -40°C To +85°C | | |
| Lead Solder Temperature[2] | 260°C For 3-5 Seconds | |

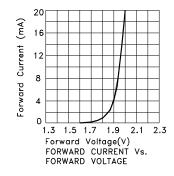
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. 2mm below package base.

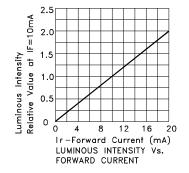
SPEC NO: DSAF0647 **REV NO: V.4** DATE: DEC/29/2010 PAGE: 2 OF 6 APPROVED: WYNEC **CHECKED:** Joe Lee DRAWN: C.H.Han ERP: 1304000324

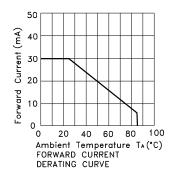
^{1.} Luminous intensity/ luminous Flux: +/-15%.

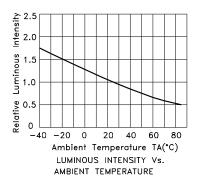


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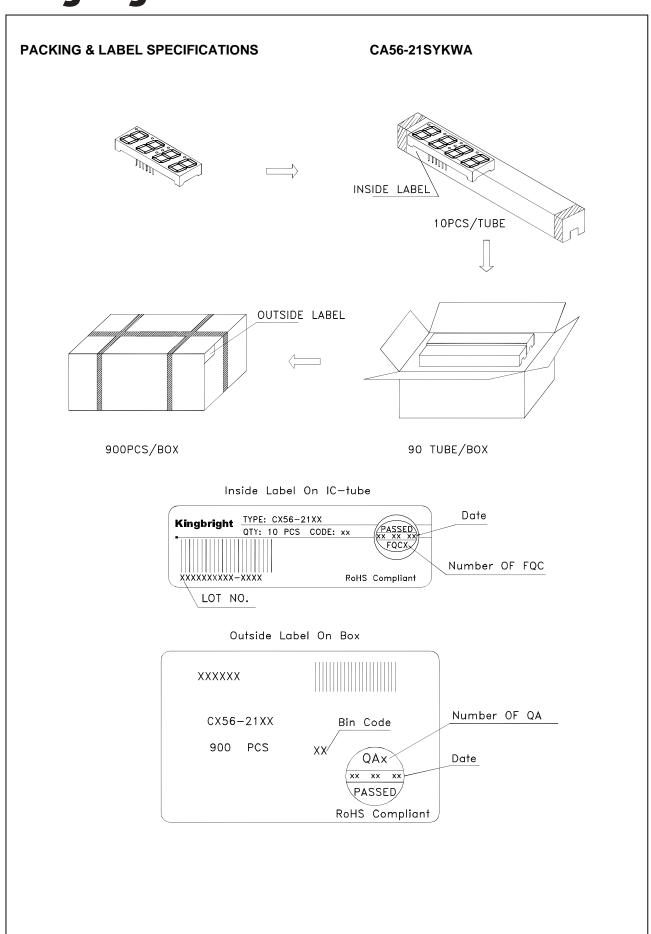


PAGE: 3 OF 6

ERP: 1304000324

SPEC NO: DSAF0647 REV NO: V.4 DATE: DEC/29/2010

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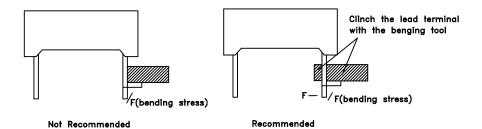


SPEC NO: DSAF0647 APPROVED: WYNEC REV NO: V.4 CHECKED: Joe Lee DATE: DEC/29/2010 DRAWN: C.H.Han PAGE: 4 OF 6 ERP: 1304000324

THROUGH HOLE DISPLAY MOUNTING METHOD

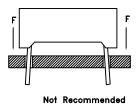
Lead Forming

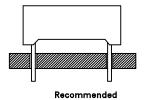
Do not bend the component leads by hand without proper tools. The leads should be bent by clinching the upper part of the lead firmly such that the bending force is not exerted on the plastic body.



Installation

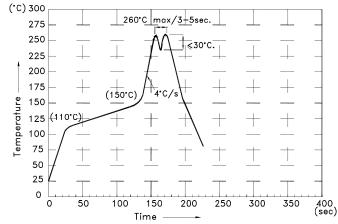
- 1. The installation process should not apply stress to the lead terminals.
- 2. When inserting for assembly, ensure the terminal pitch matches the substrate board's hole pitch to prevent spreading or pinching the lead terminals.





DISPLAY SOLDERING CONDITIONS

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3. The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- $\textbf{4.} \textbf{During wave soldering , the PCB top-surface temperature should be kept below 105 {\rm ^{\circ}C}$

5.No more than once.

SPEC NO: DSAF0647 REV NO: V.4 DATE: DEC/29/2010 PAGE: 5 OF 6

APPROVED: WYNEC CHECKED: Joe Lee DRAWN: C.H.Han ERP: 1304000324

Soldering General Notes:

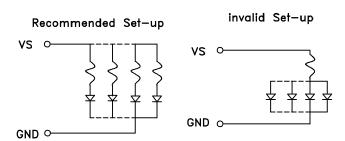
- a. Through—hole displays are incompatible with reflow soldering.
- b. If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with Kingbright for compatibility.

CLEANING

- 1.Mild "no-clean" fluxes are recommended for use in soldering.
- 2. If cleaning is required, Kingbright recommends to wash components with water only. Do not use harsh organic solvents for cleaning, because they may damage the plastic parts .And the devices should not be washed for more than one minute.

CIRCUIT DESIGN NOTES

- 1.Protective current-limiting resistors may be necessary to operate the Displays.
- 2.LEDs mounted in parallel should each be placed in series with its own current—limiting resistor.



SPEC NO: DSAF0647 APPROVED: WYNEC REV NO: V.4 CHECKED: Joe Lee DATE: DEC/29/2010 DRAWN: C.H.Han PAGE: 6 OF 6 ERP: 1304000324